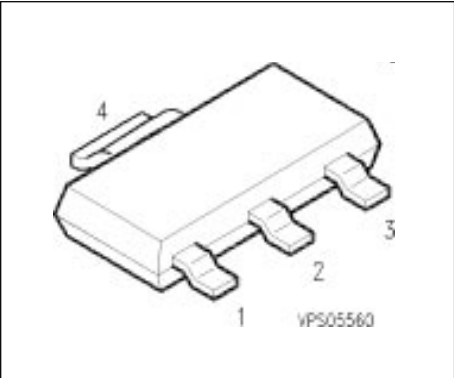


SIPMOS® Small-Signal Transistor

- P channel
- Enhancement mode
- Logic Level
- $V_{GS(th)} = -0.8 \dots -2.0 \text{ V}$



Pin 1	Pin 2	Pin 3	Pin 4
G	D	S	D

Type	V_{DS}	I_D	$R_{DS(on)}$	Package	Marking
BSP 315	-50 V	-1.1 A	0.8Ω	SOT-223	BSP 315
Type	Ordering Code		Tape and Reel Information		
BSP 315	Q67000-S75		E6327		
BSP 315	Q67000-S249		E6433		

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain source voltage	V_{DS}	-50	V
Drain-gate voltage $R_{GS} = 20 \text{ k}\Omega$	V_{DGR}	-50	
Gate source voltage	V_{GS}	± 20	
Continuous drain current $T_A = 39 \text{ }^\circ\text{C}$	I_D	-1.1	A
DC drain current, pulsed $T_A = 25 \text{ }^\circ\text{C}$	I_{Dpuls}	-4.4	
Power dissipation $T_A = 25 \text{ }^\circ\text{C}$	P_{tot}	1.8	W

Maximum Ratings

Parameter	Symbol	Values	Unit
Chip or operating temperature	T_j	-55 ... + 150	°C
Storage temperature	T_{stg}	-55 ... + 150	
Thermal resistance, chip to ambient air	R_{thJA}	≤ 70	K/W
Thermal resistance, junction-soldering point ¹⁾	R_{thJS}	≤ 10	
DIN humidity category, DIN 40 040		E	
IEC climatic category, DIN IEC 68-1		55 / 150 / 56	

1) Transistor on epoxy pcb 40 mm x 40 mm x 1,5 mm with 6 cm² copper area for drain connection

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0\text{ V}$, $I_D = -0.25\text{ mA}$, $T_j = 25^\circ\text{C}$	$V_{(BR)DSS}$	-50	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}$, $I_D = -1\text{ mA}$	$V_{GS(th)}$	-0.8	-1.1	-2	
Zero gate voltage drain current $V_{DS} = -50\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 25^\circ\text{C}$	I_{DSS}	-	-0.1	-1	μA
$V_{DS} = -50\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 125^\circ\text{C}$		-	-10	-100	
$V_{DS} = -30\text{ V}$, $V_{GS} = 0\text{ V}$, $T_j = 25^\circ\text{C}$		-	-	-100	nA
Gate-source leakage current $V_{GS} = -20\text{ V}$, $V_{DS} = 0\text{ V}$	I_{GSS}	-	-10	-100	nA
Drain-Source on-state resistance $V_{GS} = -10\text{ V}$, $I_D = -1.1\text{ A}$	$R_{DS(on)}$	-	0.65	0.8	Ω

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Dynamic Characteristics

Transconductance $V_{DS} \geq 2 * I_D * R_{DS(on)max}$, $I_D = -1.1 \text{ A}$	g_{fs}	0.25	0.7	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	300	400	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	150	230	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	85	130	
Turn-on delay time $V_{DD} = -30 \text{ V}$, $V_{GS} = -10 \text{ V}$, $I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(on)}$	-	8	12	ns
Rise time $V_{DD} = -30 \text{ V}$, $V_{GS} = -10 \text{ V}$, $I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	t_r	-	35	55	
Turn-off delay time $V_{DD} = -30 \text{ V}$, $V_{GS} = -10 \text{ V}$, $I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	$t_{d(off)}$	-	80	110	
Fall time $V_{DD} = -30 \text{ V}$, $V_{GS} = -10 \text{ V}$, $I_D = -0.29 \text{ A}$ $R_{GS} = 50 \Omega$	t_f	-	140	190	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

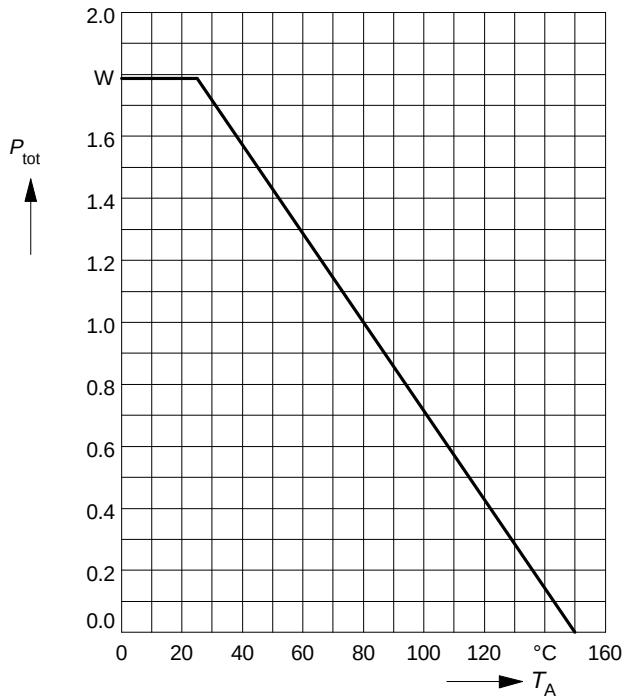
Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Reverse Diode

Inverse diode continuous forward current $T_A = 25^\circ\text{C}$	I_S	-	-	-1.1	A
Inverse diode direct current,pulsed $T_A = 25^\circ\text{C}$	I_{SM}	-	-	-4.4	
Inverse diode forward voltage $V_{GS} = 0\text{ V}$, $I_F = -2.2\text{ A}$, $T_j = 25^\circ\text{C}$	V_{SD}	-	-1.2	-1.5	V

Power dissipation

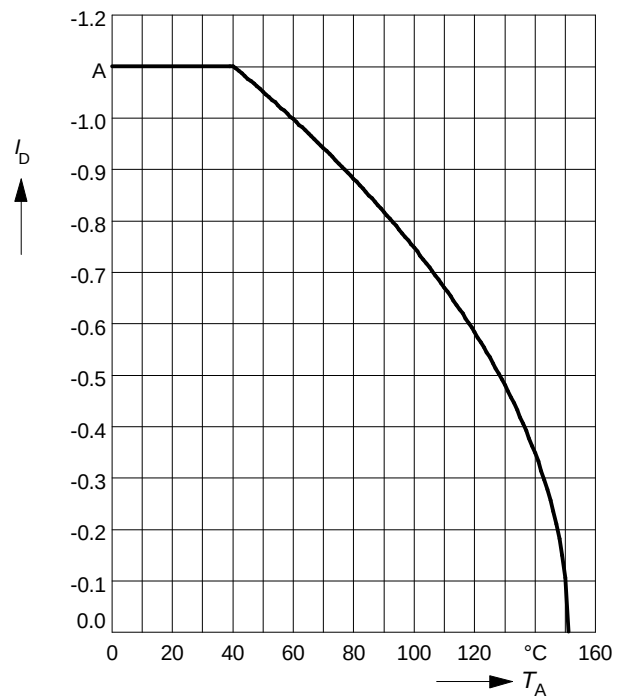
$$P_{\text{tot}} = f(T_A)$$



Drain current

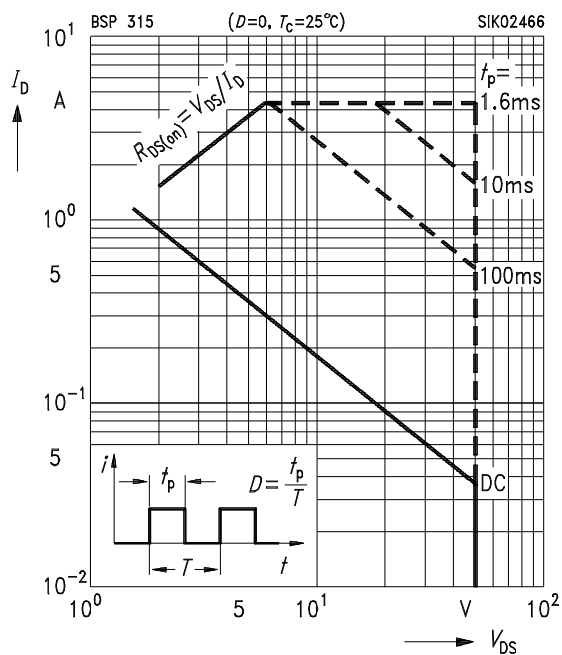
$$I_D = f(T_A)$$

parameter: $V_{GS} \geq -10 \text{ V}$



Safe operating area $I_D = f(V_{DS})$

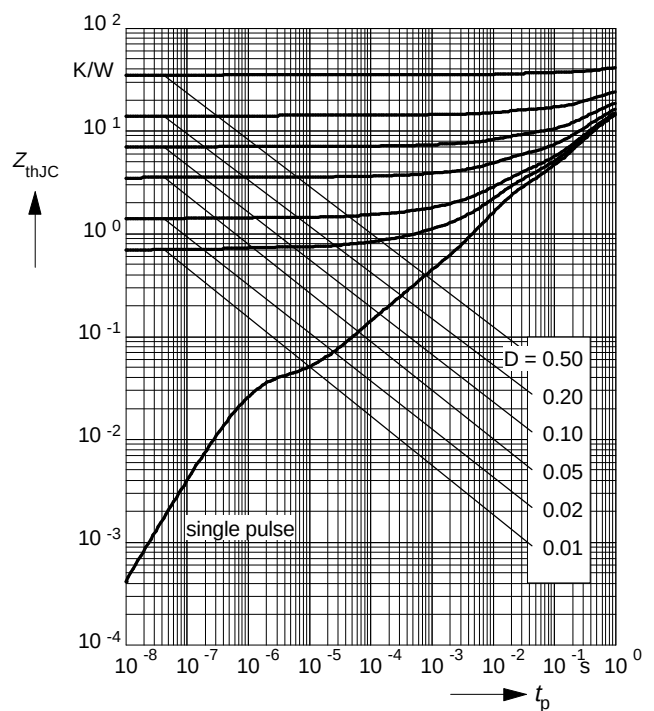
parameter: $D = 0$, $T_C = 25^\circ\text{C}$



Transient thermal impedance

$$Z_{\text{th JA}} = f(t_p)$$

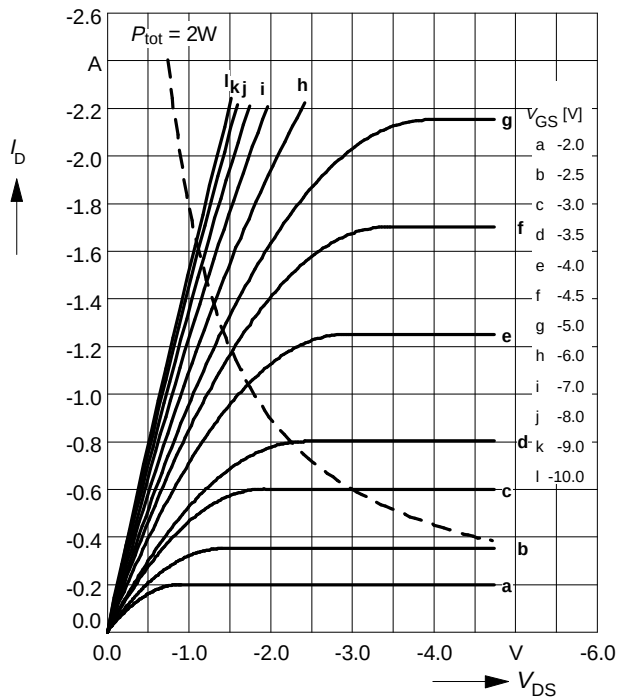
parameter: $D = t_p / T$



Typ. output characteristics

$$I_D = f(V_{DS})$$

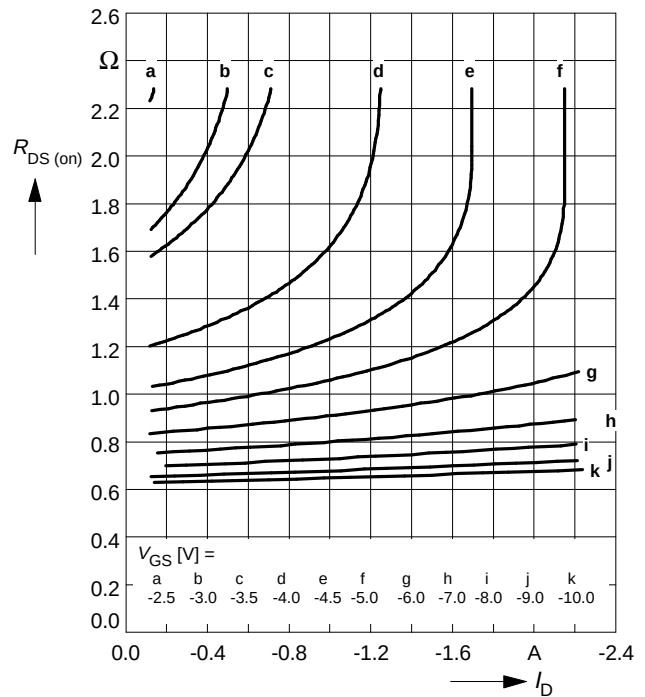
parameter: $t_p = 80 \mu s$



Typ. drain-source on-resistance

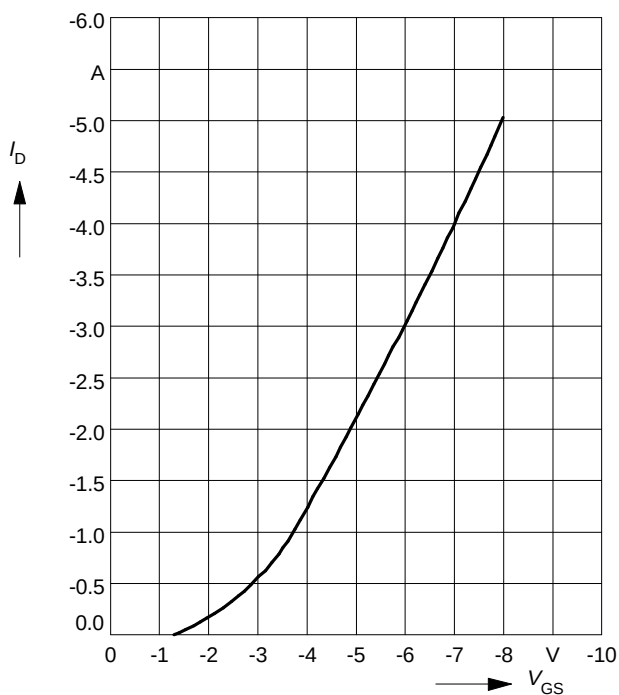
$$R_{DS(on)} = f(I_D)$$

parameter: $t_p = 80 \mu s$, $T_j = 25^\circ C$



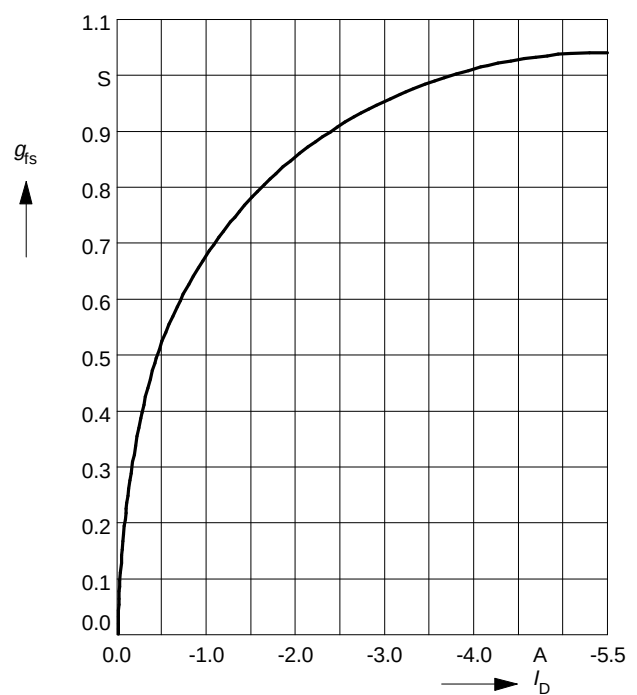
Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu s$



Typ. forward transconductance $g_{fs} = f(I_D)$

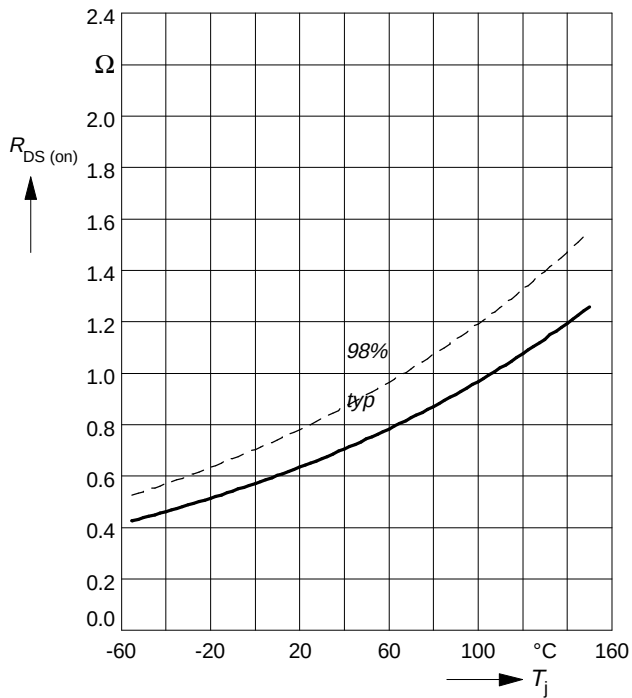
parameter: $t_p = 80 \mu s$,



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

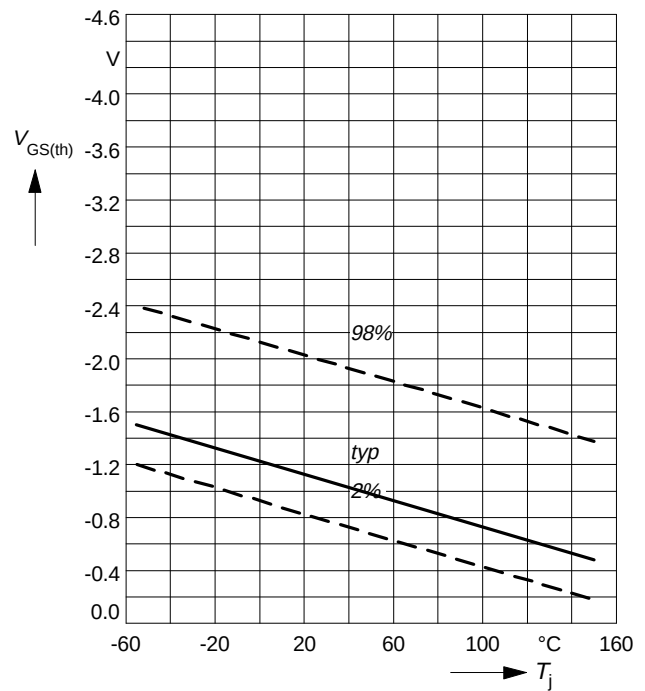
parameter: $I_D = -1.1$ A, $V_{GS} = -10$ V



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

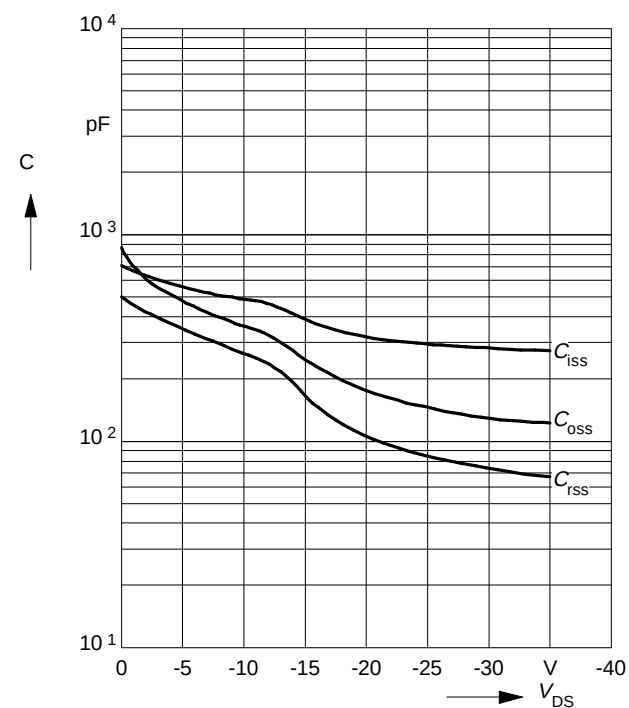
parameter: $V_{GS} = V_{DS}$, $I_D = -1$ mA



Typ. capacitances

$$C = f(V_{DS})$$

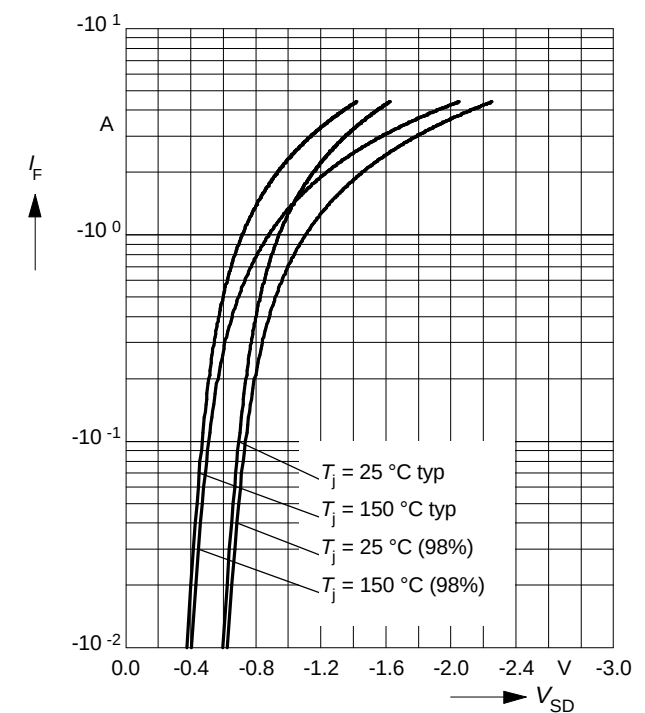
parameter: $V_{GS}=0$ V, $f = 1$ MHz



Forward characteristics of reverse diode

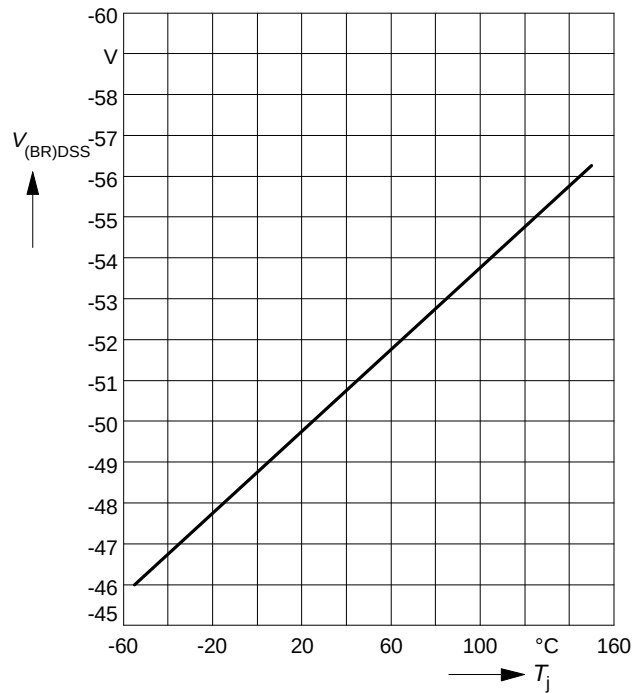
$$I_F = f(V_{SD})$$

parameter: $T_j, t_p = 80$ μs



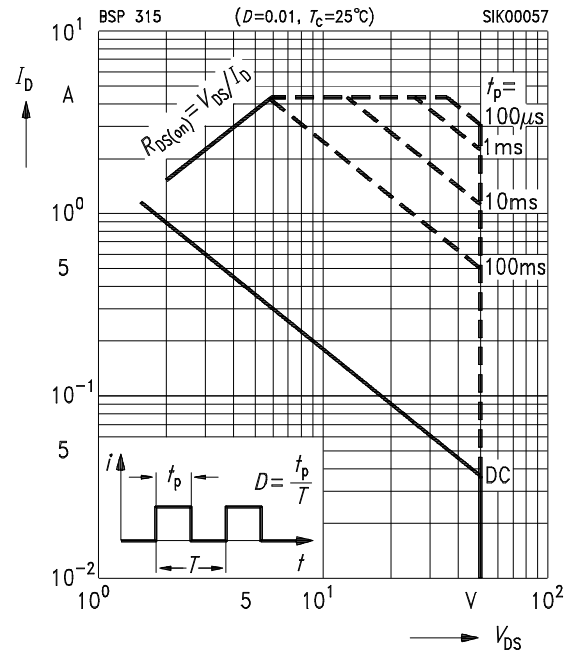
Drain-source breakdown voltage

$$V_{(BR)DSS} = f(T_j)$$



Safe operating area $I_D = f(V_{DS})$

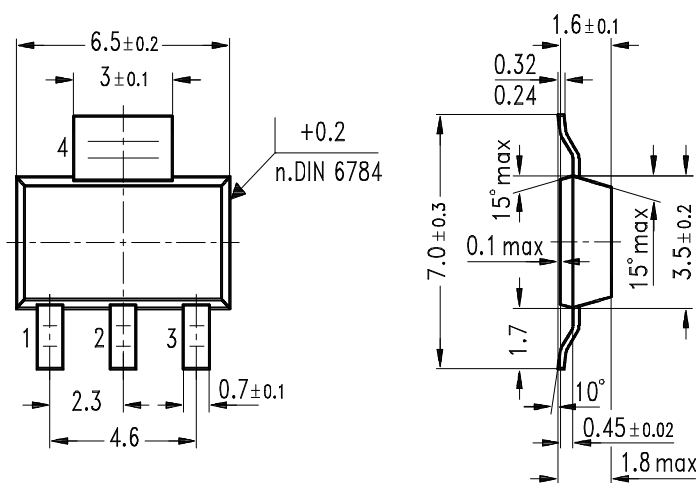
parameter : $D = 0.01$, $T_c = 25^\circ\text{C}$



Package outlines

SOT-223

Dimensions in mm



GPS05560